

HAT2164H

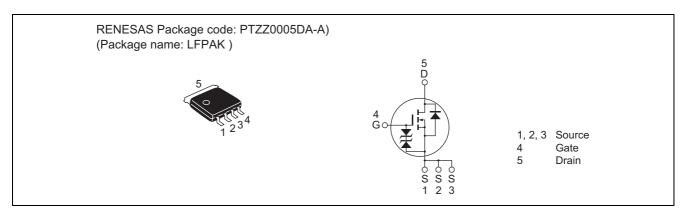
Silicon N Channel Power MOS FET Power Switching

REJ03G0003-0500 Rev.5.00 Sep 26, 2005

Features

- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance $R_{DS(on)} = 2.5 \text{ m}\Omega \text{ typ. (at } V_{GS} = 10 \text{ V)}$

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	30	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I _D	60	А
Drain peak current	I _{D(pulse)} Note1	240	А
Body-drain diode reverse drain current	I _{DR}	60	А
Avalanche current	I _{AP} Note 2	30	А
Avalanche energy	E _{AR} Note 2	90	mJ
Channel dissipation	Pch Note3	30	W
Channel to Case Thermal Resistance	θch-C	4.17	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tch = 25°C, Rg \geq 50 Ω

3. Tc = 25°C

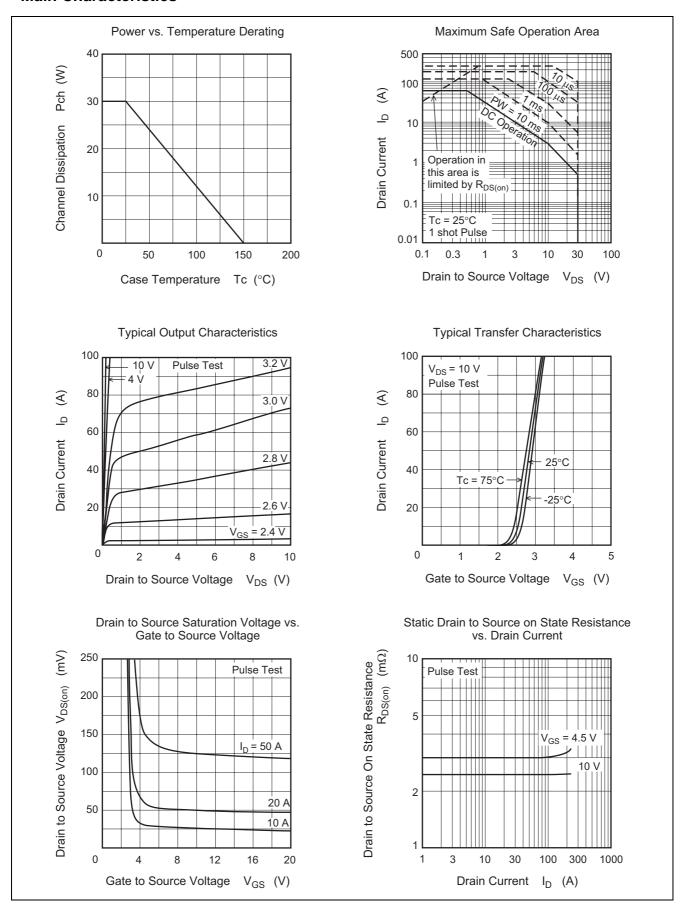
Electrical Characteristics

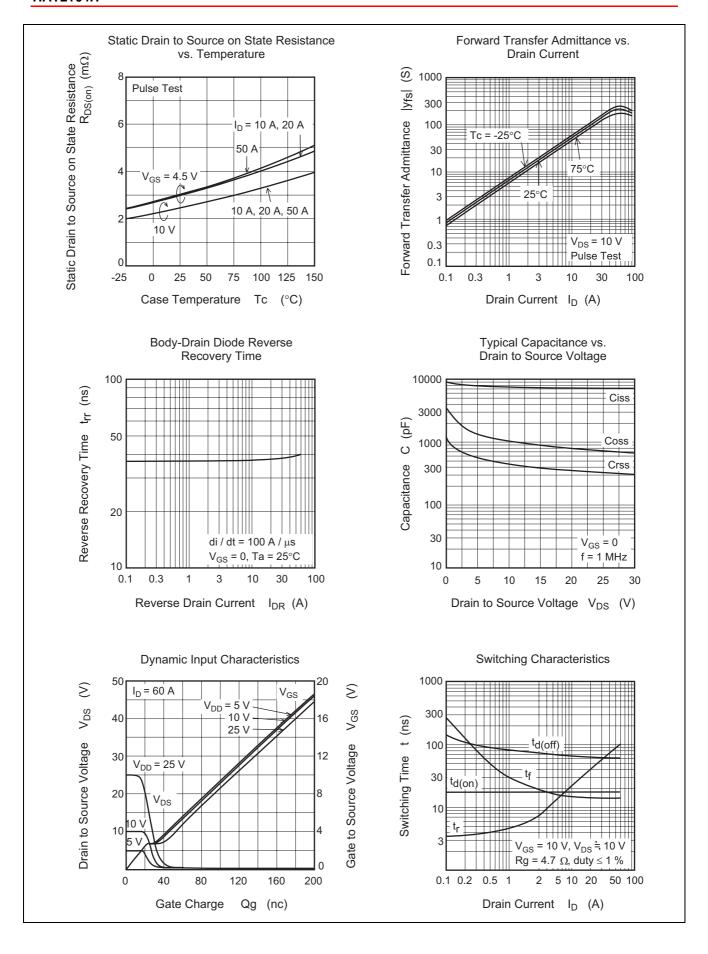
 $(Ta = 25^{\circ}C)$

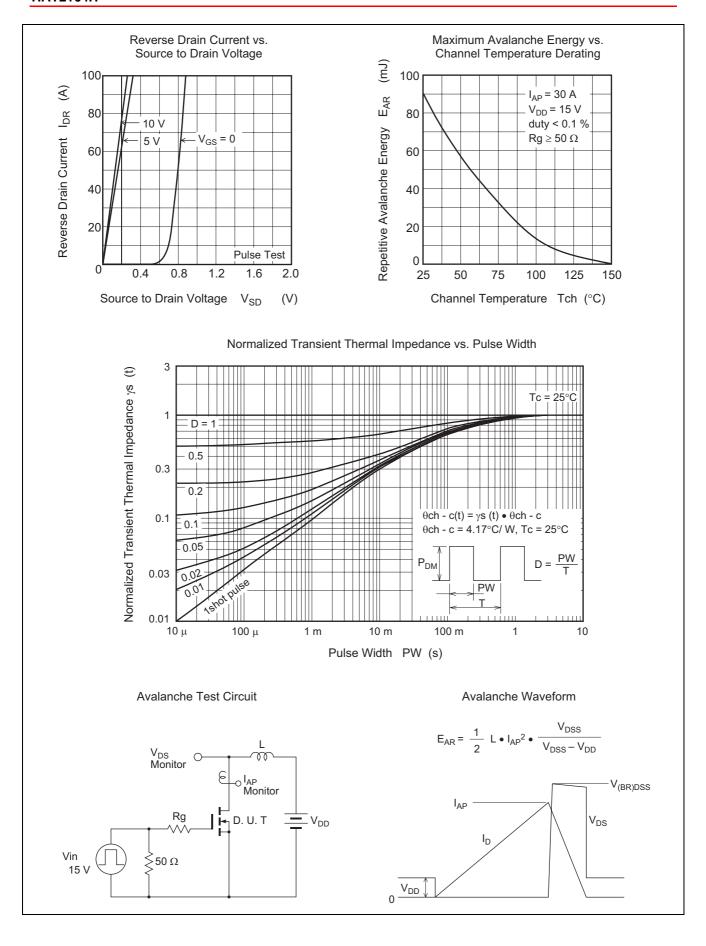
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30			V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20			V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_		±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_		1	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	0.8		2.3	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}	_	2.5	3.1	mΩ	$I_D = 30 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance	R _{DS(on)}	_	3.0	4.4	mΩ	$I_D = 30 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y _{fs}	78	130		S	$I_D = 30 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	_	7600	1	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$
Output capacitance	Coss	_	1050		pF	
Reverse transfer capacitance	Crss	_	470	_	pF	
Gate Resistance	Rg	_	0.5	_	Ω	
Total gate charge	Qg	_	50	_	nC	$V_{DD} = 10 \text{ V}, V_{GS} = 4.5 \text{ V},$
Gate to source charge	Qgs	_	22	_	nC	$I_D = 60 \text{ A}$
Gate to drain charge	Qgd	_	10	_	nC	
Turn-on delay time	t _{d(on)}	_	18	_	ns	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A},$
Rise time	t _r	_	60	_	ns	$V_{DD} \cong 10 \text{ V}, \text{ R}_L = 0.33 \Omega,$
Turn-off delay time	t _{d(off)}	_	65	_	ns	$Rg = 4.7 \Omega$
Fall time	t _f	_	15	_	ns	
Body-drain diode forward voltage	V_{DF}	_	0.82	1.07	V	IF = 60 A, V _{GS} = 0 Note4
Body-drain diode reverse recovery	t _{rr}	_	40	_	ns	IF = 60 A, V _{GS} = 0
time						di _F / dt = 100 A/ μs

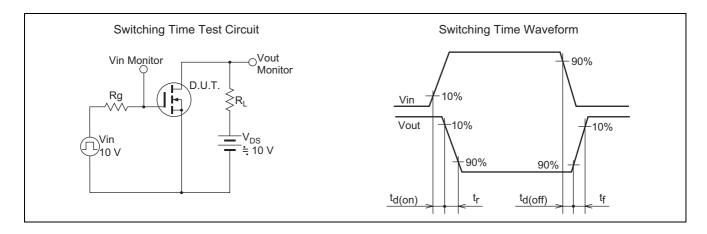
Notes: 4. Pulse test

Main Characteristics

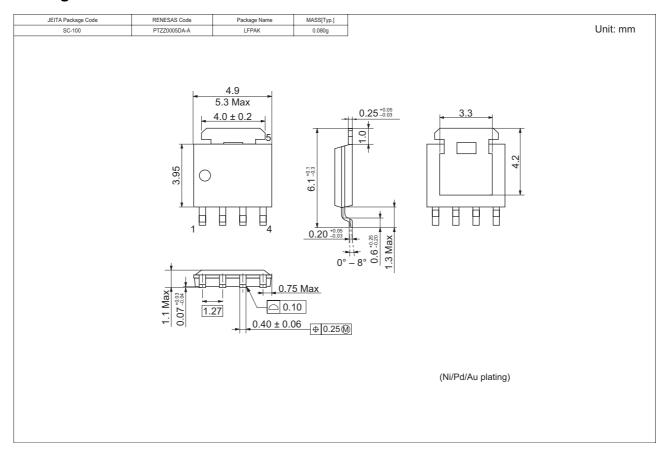








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2164H-EL-E	2500 pcs	Taping

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